

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









Description

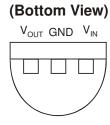
The AP78LXX Series is a three terminal positive regulator available with fixed output voltages from 5V, 8V and 12V, making them useful in a wide range of applications. When used as a Zener diode/resistor combination replacement, the AP78LXX can improve output impedance by two orders of magnitude, and lower quiescent current. These regulators can provide local on card regulation, eliminating the distribution problems associated with single point regulation. The voltages available allow the AP78LXX's to be used in logic systems. Instrumentation, HiFi and other solid state electronic equipment.

The AP78LXX is available in the plastic TO92, SOT89 and SO-8 using industrial standard package technology. The regulator can deliver 100mA output current with adequate heat sinking. Current limiting is included to limit the peak output current to a safe value. Safe area protection for the output transistors is provided to limit internal power dissipation. Thermal overload protection is integrated to prevent the IC from overheat due to abnormal condition.

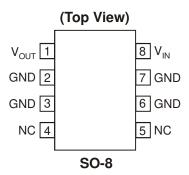
Features

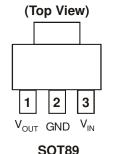
- Output voltages of 5.0V, 8.0V, 12V
- Output voltage tolerances of ±5% over the operating temperature ranges
- Output current in excess of 100mA
- Internal thermal overload protection
- Output transistor safe area protection
- Internal short circuit current limiting
- · No external components
- Available in plastic TO92, SOT89 and plastic SO-8 low profile packages
- Lead Free Package: TO92 (Note 1)
- SO-8 and SOT89: Available in "Green" Molding Compound (No Br, Sb) (Note 2)
- Lead Free Finish / RoHS Compliant (Note 3)

Pin Assignments



TO92





Applications

- Communication
- CD-ROM
- DVD-Player
- Set-Top Box

- 1. TO92 is available in "Lead Free" product only.
- 2. SO-8 and SOT89 are available in "Green" products only.
- 3. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2). All applicable RoHS exemptions applied.



Typical Application Circuit

Input AP78Lxx $C1^{\dagger}$ GND $C2^{\dagger}$ $0.1\mu F$

- (†) Required if the regulator is located more than 3" from the power supply filter
- (‡) See Note 5 in the electrical characteristics table

Pin Descriptions

Pin Name	Description	
V _{IN}	Operating Voltage Input	
V _{OUT}	Voltage Output Pin	
GND	Ground	
NC	No Connection	

Functional Block Diagram

Introduction

The AP78LXX series is a three terminal device with fixed output voltages from 5V,8V and 12V. The AP78LXX fixed voltage regulator series has built-in thermal overload protection which prevents the device from being damaged due to excessive junction temperature. The regulator also contains internal short-circuit protection which limits the maximum output current, and safe-area protection for the pass transistor which reduces the short-circuit current as the voltage across the pass transistor is increased.



Absolute Maximum Ratings (T_A = 25°C)

Symbol	Parameter		Rating	Unit
ESD HBM	Human Body Model ESD Protect	ion	3	KV
ESD MM	Machine Model ESD Protection		250	V
V _{CC}	Supply Voltage		30	V
		AP78L05	5	
V _{OUT}	Output Voltage to Ground	AP78L08	8	V
		AP78L12	12	
T _{ST}	Storage Temperature		-65 to +150	°C
T _{OP}	Operating Junction Temperature		-20 to +125	°C
T _{MJ}	Maximum Junction Temperature		150	°C

Recommended Operating Conditions (T_A = 25°C)

Symbol	Parameter		Min	Max	Unit
		AP78L05	7	20	
V _{IN}	Input Voltage	AP78L08	10.5	23	V
		AP78L12	14.5	27	
l _{OUT}	Output Current		0	100	mA
T _A	Operating Ambient Temperature		-20	+85	°C



AP78Lxx Electrical Characteristics (All Output Voltage Versions)

Limits in standard typeface are for $T_A = 25$ °C, Bold typeface applies over $T_J = -20$ °C to +125°C for TO92, SOT89 and SO-8 packages. Unless otherwise specified: I_O = 40mA, C_I = 0.33 μ F, C_O = 0.1 μ F.

AP78L05

Unless otherwise specified, $V_{IN} = 10V$

Symbol	Parameter	Conditions	Min	Тур.	Max	Unit	
			4.8	5	5.2		
Vo	Output Voltage	$7V \le V_{IN} \le 20V$ $1mA \le I_O \le 40mA$	4.75		5.25	V	
		$1mA \leq I_O \leq 70mA$	4.75		5.25		
41/-	Line Degulation	$7V \leq V_{IN} \leq 20V$		18	75	mV	
ΔV _O	Line Regulation	$8V \leq V_{IN} \leq 20V$		10	54	IIIV	
41/	Lood Domilation	$1mA \leq I_O \leq 100mA$		20	60	\/	
ΔV _O	Load Regulation	$1mA \leq I_O \leq 40mA$		5	30	mV	
IQ	Quiescent Current			3	5		
Al	Outline a set Commant Chairm	$8V \leq V_{IN} \leq 20V$			1.0	mA	
ΔlQ	Quiescent Current Change	$1mA \le I_O \le 40mA$			0.1		
V _N	Output Noise Voltage	f = 10Hz to 100kHz (Note 4)	-	40		μV	
$\Delta V_{IN}/\Delta V_{OUT}$	Ripple Rejection	$f = 120Hz$ $8V \le V_{IN} \le 16V$	47	62		dB	
I _{PK}	Peak Output Current			140		mA	
$\Delta V_O/\Delta T$	Average Output Voltage Tempco	$I_O = 5mA$		-0.65		mV/°C	
V _{IN(MIN)}	Minimum Value of Input Voltage Required to Maintain Line Regulation			6.7	7	V	
		TO92 (Note 5)		176			
θ_{JA}	Thermal Resistance Junction to Ambient	SO-8 (Note 6)		153			
	, and one	SOT89 (Note 7)		145		°C/W	
		TO92 (Note 5)		33		C/VV	
θ_{JC}	Thermal Resistance Junction to Case	SO-8 (Note 6)		18			
		SOT89 (Note 7)		25			

- 4. Recommend $0.01\mu F$ minimum load capacitance at output to suppress high frequency noise.
- 5. Test conditions for TO92: No heat sink, no air flow.
- 6. Test conditions for SO-8: Device mounted on 2oz copper, minimum recommended pad layout, FR-4 PCB.

 7. Test conditions for SOT89: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



AP78Lxx Electrical Characteristics (cont.)

AP78L08

Unless otherwise specified, $V_{IN} = 14V$

Symbol	Parameter	Conditions	Min	Тур.	Max	Unit	
			7.7	8	8.3		
Vo	Output Voltage	$10.5V \le V_{IN} \le 23V$ $1mA \le I_O \le 40mA$	7.6		8.4	V	
		$1mA \le I_O \le 70mA$	7.6		8.4		
437	Line Decodetion	$10.5V \leq V_{IN} \leq 23V$		42	175		
ΔV_{O}	Line Regulation	$11V \leq V_{IN} \leq 23V$		36	125	mV	
41/	Lood Domilation	$1mA \leq I_O \leq 100mA$		18	80	, mal /	
ΔV_{O}	Load Regulation	$1mA \leq I_O \leq 40mA$		10	40	mV	
ΙQ	Quiescent Current			2	5.5		
4.1	0 : 10 10	$11V \leq V_{IN} \leq 23V$			1.5	mA	
Δl_{Q}	Quiescent Current Change	$1mA \le I_O \le 40mA$			0.1	1	
V _N	Output Noise Voltage	f = 10Hz to 100kHz (Note 4)	-	54		μV	
$\Delta V_{IN}/\Delta V_{OUT}$	Ripple Rejection	$f = 120Hz$ $13V \le V_{IN} \le 23V$	37	46		dB	
I _{PK}	Peak Output Current			140		mA	
$\Delta V_O/\Delta T$	Average Output Voltage Tempco	$I_O = 5mA$		-0.8		mV/°C	
V _{IN(MIN)}	Minimum Value of Input Voltage Required to Maintain Line Regulation			9.7		V	
		TO92 (Note 5)		176			
θ_{JA}	Thermal Resistance Junction to	SO-8 (Note 6)		153		°C/W	
	Ambient	SOT89 (Note 7)		157			
		TO92 (Note 5)		33			
θ_{JC}	Thermal Resistance Junction to case	SO-8 (Note 6)		18		°C/W	
		SOT89 (Note 7)		33			

 ^{4.} Recommend 0.01μF minimum load capacitance at output to suppress high frequency noise.
 5. Test conditions for TO92: No heat sink, no air flow.
 6. Test conditions for SO-8: Device mounted on 2oz copper, minimum recommended pad layout, FR-4 PCB.
 7. Test conditions for SOT89: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



AP78Lxx Electrical Characteristics (cont.)

AP78L12

Unless otherwise specified, $V_{IN} = 19V$

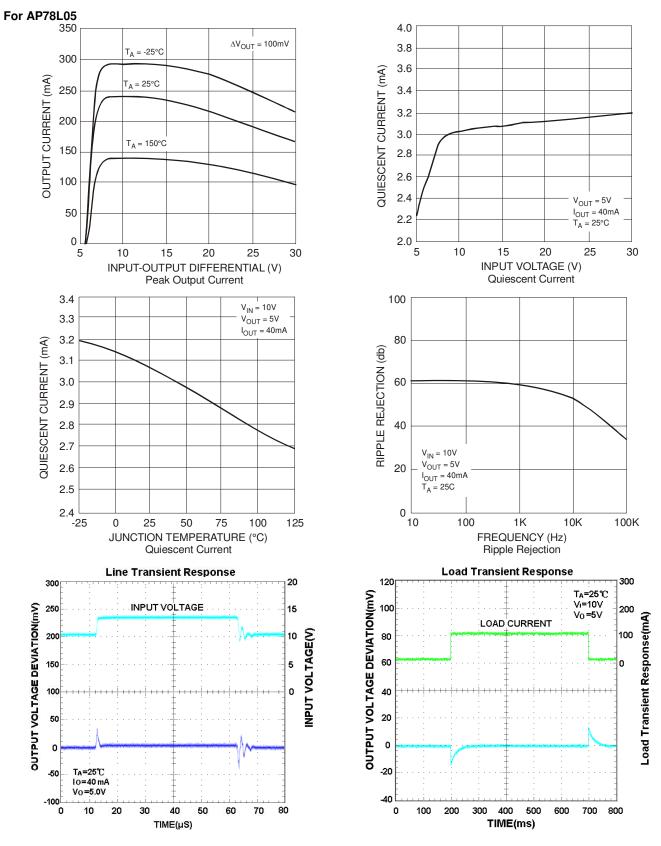
Symbol	Parameter	Conditions	Min	Тур.	Max	Unit	
			11.5	12	12.5		
Vo	Output Voltage	$14.5V \le V_{IN} \le 27V$ $1mA \le I_O \le 40mA$	11.4		12.6	v	
		$1mA \le I_O \le 70mA$	11.4		12.6		
437	Line Demoleties	$14.5V \leq V_{IN} \leq 27V$		30	180	/	
ΔV_{O}	Line Regulation	$16V \leq V_{IN} \leq 27V$		20	110	mV	
41/	Load Description	$1mA \leq I_O \leq 100mA$		30	100	/	
ΔV_{O}	Load Regulation	$1mA \leq I_O \leq 40mA$		10	50	mV	
ΙQ	Quiescent Current			3	5		
41	Quigagent Current Change	$16V \leq V_{IN} \leq 27V$			1	mA	
ΔlQ	Quiescent Current Change	$1mA \leq I_O \leq 40mA$			0.1		
V_N	Output Noise Voltage			80		μV	
$\Delta V_{IN}/\Delta V_{OUT}$	Ripple Rejection	f = 120Hz $15V \le V_{IN} \le 25V$	40	54		dB	
I _{PK}	Peak Output Current			140		mA	
$\Delta V_{O}/\Delta T$	Average Output Voltage Tempco	I _O = 5mA		-1.0		mV/°C	
V _{IN(MIN)}	Minimum Value of Input Voltage Required to Maintain Line Regulation			13.7	14.5	V	
	T. 15	TO92 (Note 5)		176			
θ_{JA}	Thermal Resistance Junction to Ambient	SO-8 (Note 6)		153		°C/W	
	to Ambient	SOT89 (Note 7)		145			
	Thormal Decistores Investiga	TO92 (Note 5)		33			
θ_{JC}	Thermal Resistance Junction to case	SO-8 (Note 6)		18		°C/W	
		SOT89 (Note 7)		25			

- 5. Test conditions for TO92: No heat sink, no air flow.
- 6. Test conditions for SO-8: Device mounted on 2oz copper, minimum recommended pad layout, FR-4 PCB.

 7. Test conditions for SOT89: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



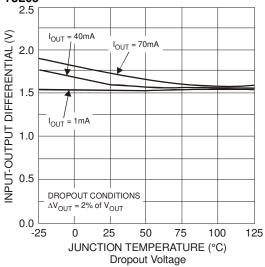
Typical Performance Characteristics





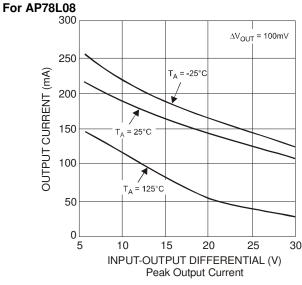
Typical Performance Characteristics (cont.)

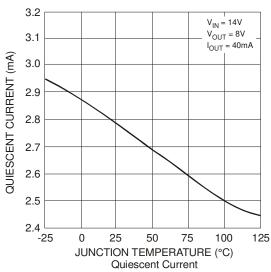
For AP78L05

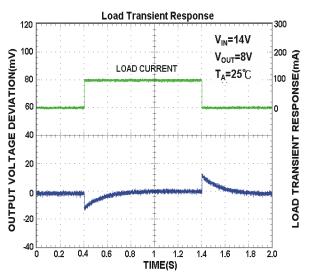


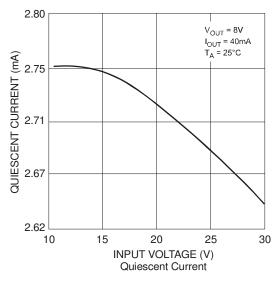


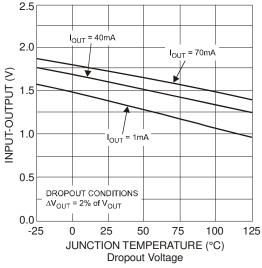
Typical Performance Characteristics









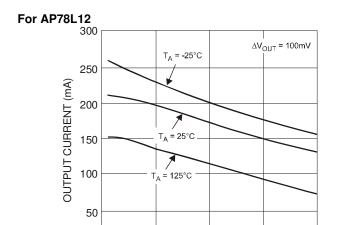


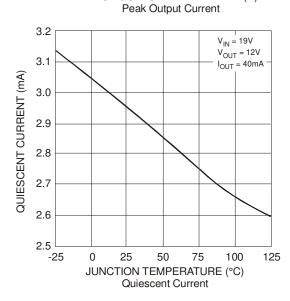


14

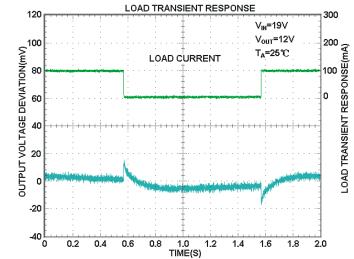
AP78LXX SERIES 3-TERMINAL POSITIVE REGULATORS

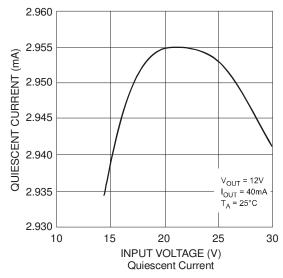
Typical Performance Characteristics (cont.)

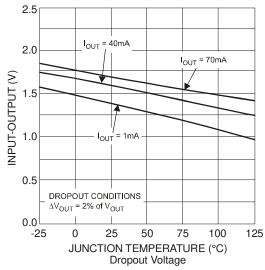




INPUT-OUTPUT DIFFERENTIAL (V)

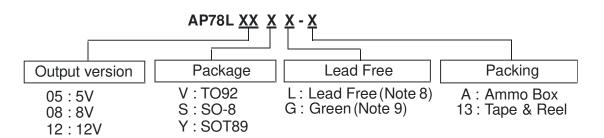








Ordering Information



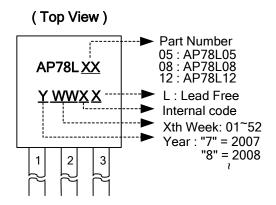
		Dookono	Dookoaina	Ammo Box / Tube		13" Tape and Reel	
	Device	Package Code	Packaging (Note 10)	Quantity	Part Number Suffix	Quantity	Part Number Suffix
Pb	AP78LXXVL-A	V	TO92	2000/Box	-A	NA	NA
Pb ,	AP78LXXSG-13	S	SO-8	NA	NA	2500/Tape & Reel	-13
PD	AP78LXXYG-13	Υ	SOT89	NA	NA	2500/Tape & Reel	-13

- 8. TO92 is available in "Lead Free" product only.9. SO-8 and SOT89 are available in "Green" products only.10. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

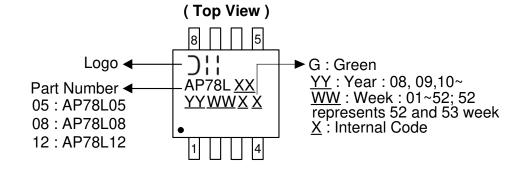


Marking Information

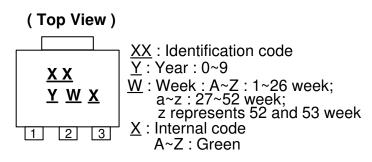
(1) TO92



(2) SO-8



(3) SOT89

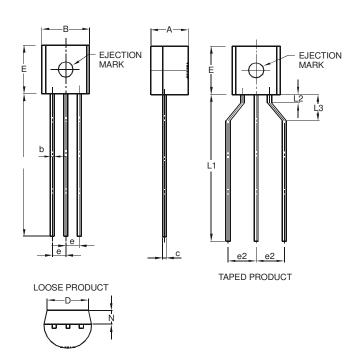


Device	Package	Identification Code
AP78L05	SOT89	V2
AP78L08	SOT89	V3
AP78L12	SOT89	V4



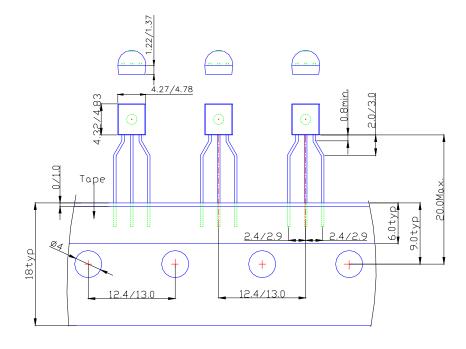
Package Outline Dimensions (All Dimensions in mm)

(1) Package Type: TO92



	TO9	2-3L	
Dim	Min	Max	Тур
Α	3.45	3.66	-
В	4.27	4.78	ı
b	1	1	0.38
С	ı	1	0.38
D	1	ı	3.87
Е	4.32	4.83	,
е	1	-	1.27
e2	2.40	2.90	-
L	12.98	15.00	ı
L1	12.80	15.00	1
L2	0.80	-	-
L3	2.00	3.00	-
N	1.22	1.37	-
All D	imensi	ions in	mm

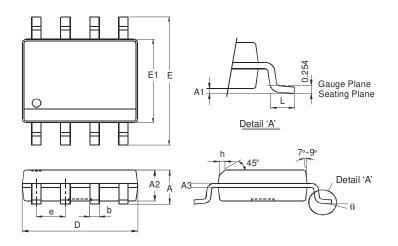
(2) TO92 for Ammo pack





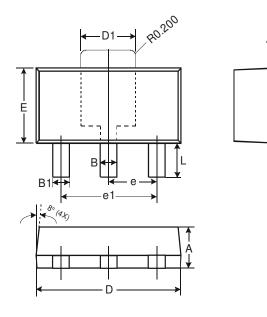
Package Outline Dimensions (cont.) (All Dimensions in mm)

(3) Package Type: SO-8



	SO-8				
Dim	Min	Max			
Α	ı	1.75			
A 1	0.10	0.20			
A2	1.30	1.50			
А3	0.15	0.25			
b	0.3	0.5			
D	4.85	4.95			
Е	5.90	6.10			
E1	3.85	3.95			
е	1.27	Тур			
h	ı	0.35			
L	0.62	0.82			
θ	0°	8°			
All Dir	nensions	s in mm			

(4) Package Type: SOT89

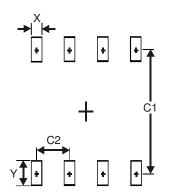


	SOT89			
Dim	Min	Max		
Α	1.40	1.60		
В	0.44	0.62		
B1	0.35	0.54		
O	0.35	0.43		
D	4.40	4.60		
D1	1.52	1.83		
ш	2.29	2.60		
е	1.50	Тур		
e1	3.00 Typ			
Н	3.94 4.25			
L	0.89	1.20		
All D	All Dimensions in mm			



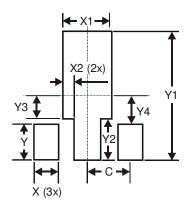
Suggested Pad Layout (All Dimensions in mm)

(1) Package Type: SO-8



Dimensions	Value (in mm)
X	0.60
Υ	1.55
C1	5.4
C2	1.27

(2) Package Type: SOT89



Dimensions	Value (in mm)
Х	0.900
X1	1.733
X2	0.416
Υ	1.300
Y1	4.600
Y2	1.475
Y3	0.950
Y4	1.125
С	1 500



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2012. Diodes Incorporated

www.diodes.com